

MECHANICAL CASE OUTLINE

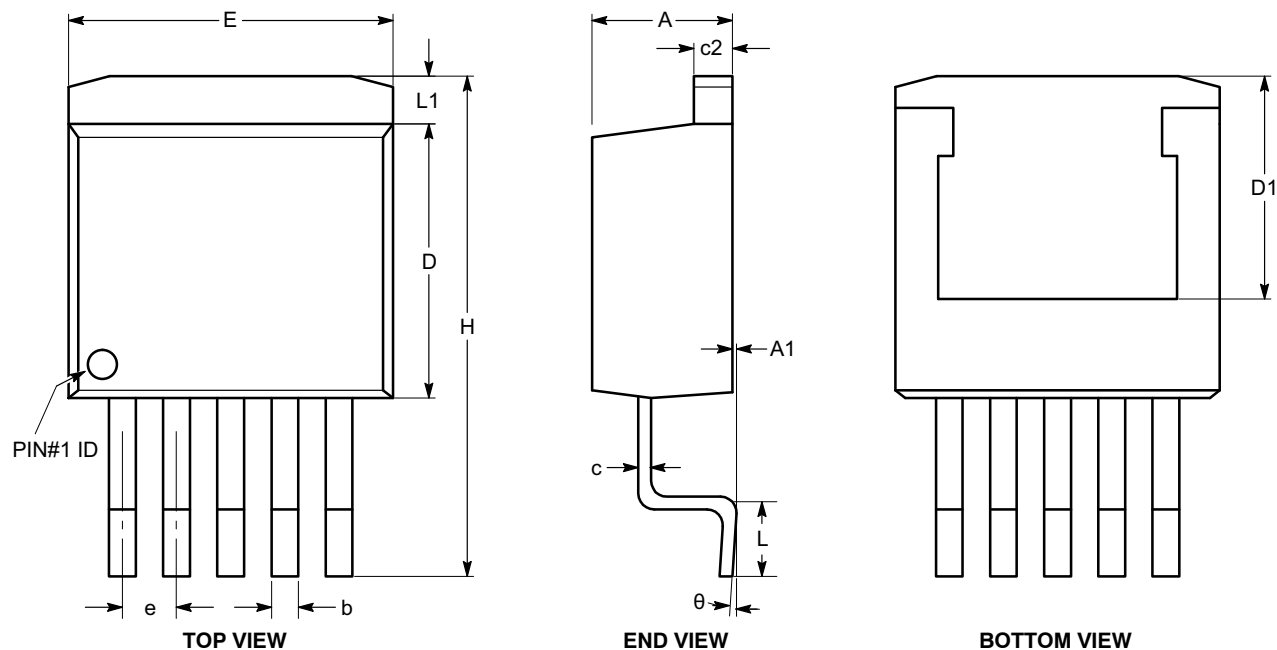
PACKAGE DIMENSIONS

ON Semiconductor®



TO-263, 5 Lead
CASE 221AE-01
ISSUE O

DATE 19 DEC 2008



SYMBOL	MIN	NOM	MAX
A	4.20		4.80
A1	0.00		0.25
b	0.60		0.88
c	0.33		0.50
c2	1.15		1.60
D	8.40		9.60
D1	6.86		
E	9.80		10.67
e	1.70 BSC		
H	14.61		15.87
L	1.78		2.79
L1			1.67
θ	0°		8°

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC standard TO-263.

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DESCRIPTION:	TO-263, 5 LEAD	PAGE 1 OF 1

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